

ABSTRACT

5 According to a method for producing a microtransponder, an  
antenna metallization having a first and a second connecting  
end is first applied to a support substrate so as to form a  
first module. A connecting metallization is applied to a  
flexible support foil, whereupon a circuit chip having a  
10 first and a second connecting area is applied to said con-  
necting metallization in such a way that at least the first  
connecting area of the circuit chip is connected to said con-  
necting metallization in an electrically conductive manner.  
The flexible support foil having the circuit chip applied  
15 thereto represents a second module. The first and the second  
module are subsequently joined in such a way that the con-  
necting metallization is connected to the first connecting  
end of the antenna metallization in an electrically conduc-  
tive manner and the second connecting area of the circuit  
20 chip is connected to the second connecting end of the antenna  
metallization in an electrically conductive manner. Finally,  
edge areas of the flexible support foil are joined to  
neighbouring areas of the support substrate so as to encapsu-  
late at least the circuit chip.

25